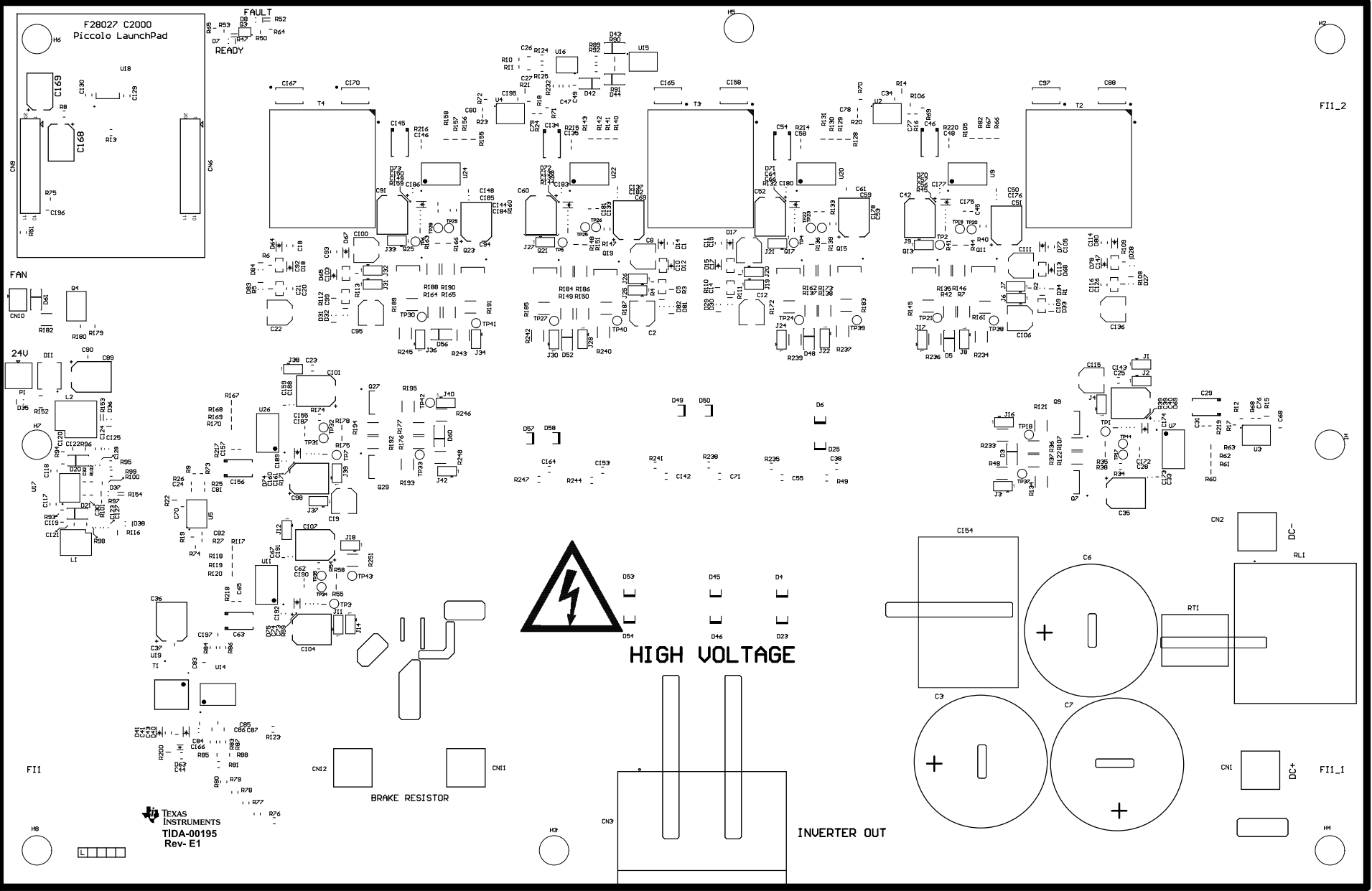
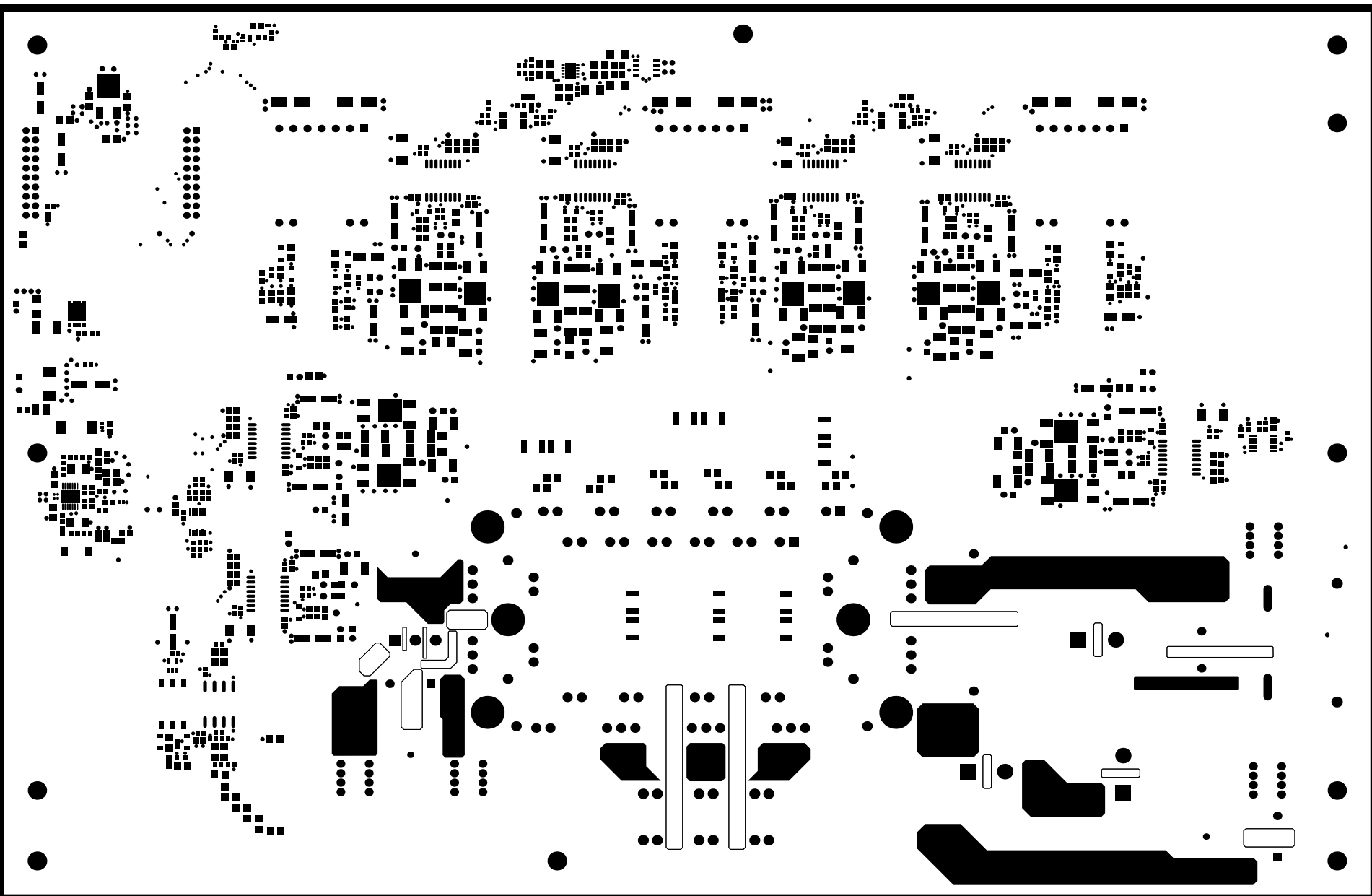


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = TOP PASTE			
PLOT NAME = Top Paste Mask Print	GENERATED : 23-03-2015 18:04:49	TEXAS INSTRUMENTS	

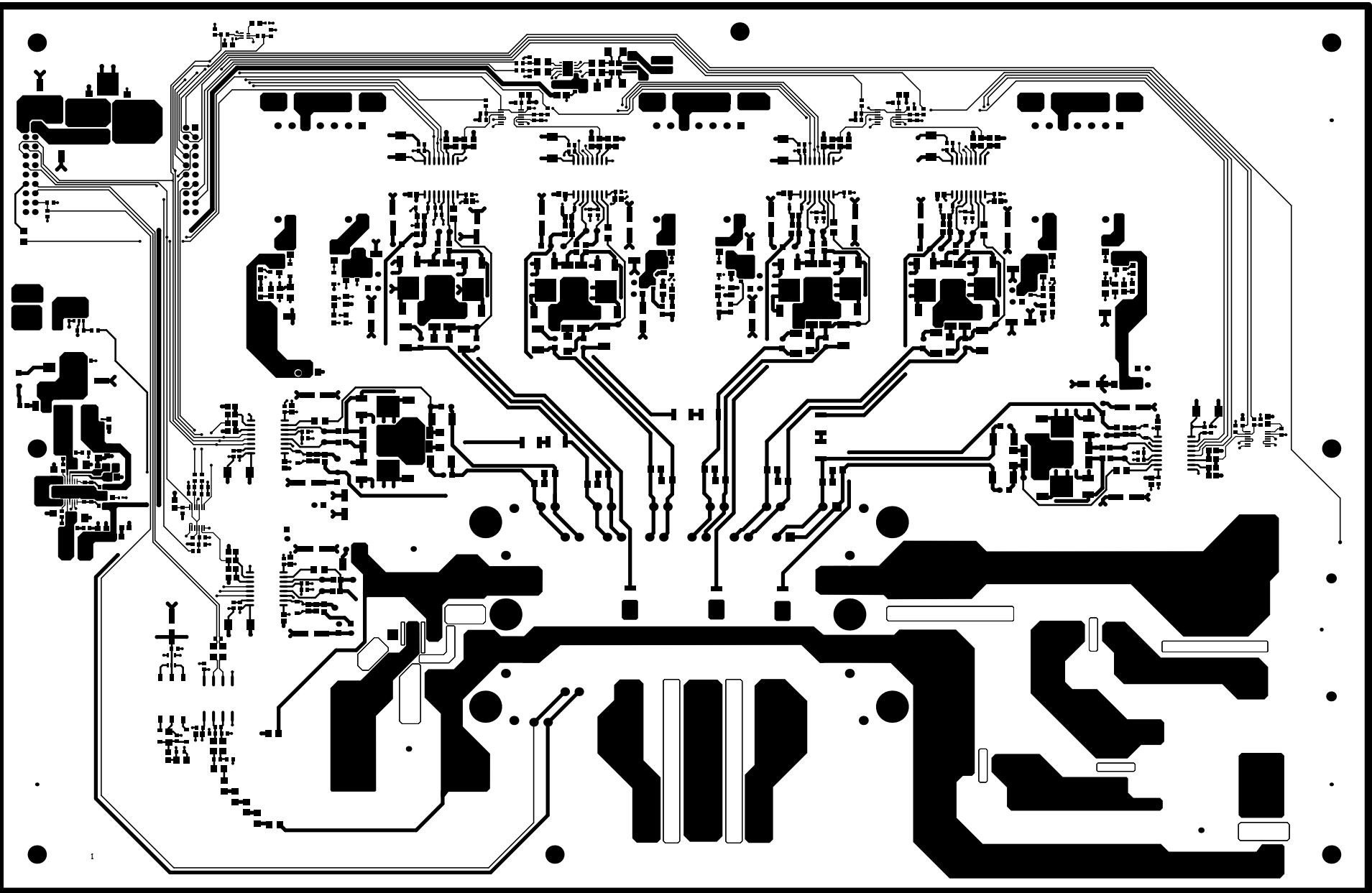


TEXAS INSTRUMENTS
TIDA-00195
Rev- E1

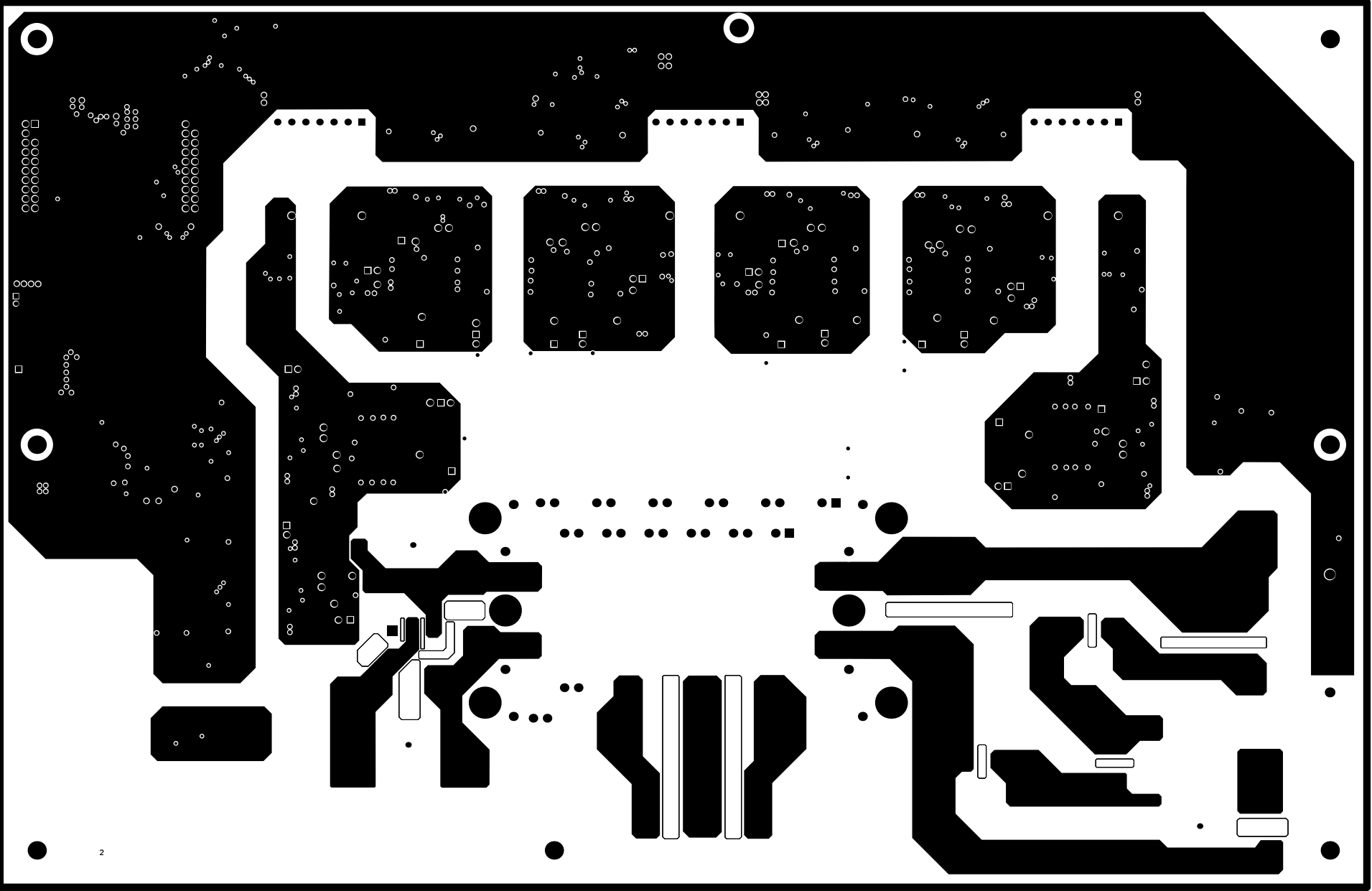
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = TOP OVERLAY			
PLOT NAME = Top Silkscreen Overlay	GENERATED : 23-03-2015 18:04:49	TEXAS INSTRUMENTS	



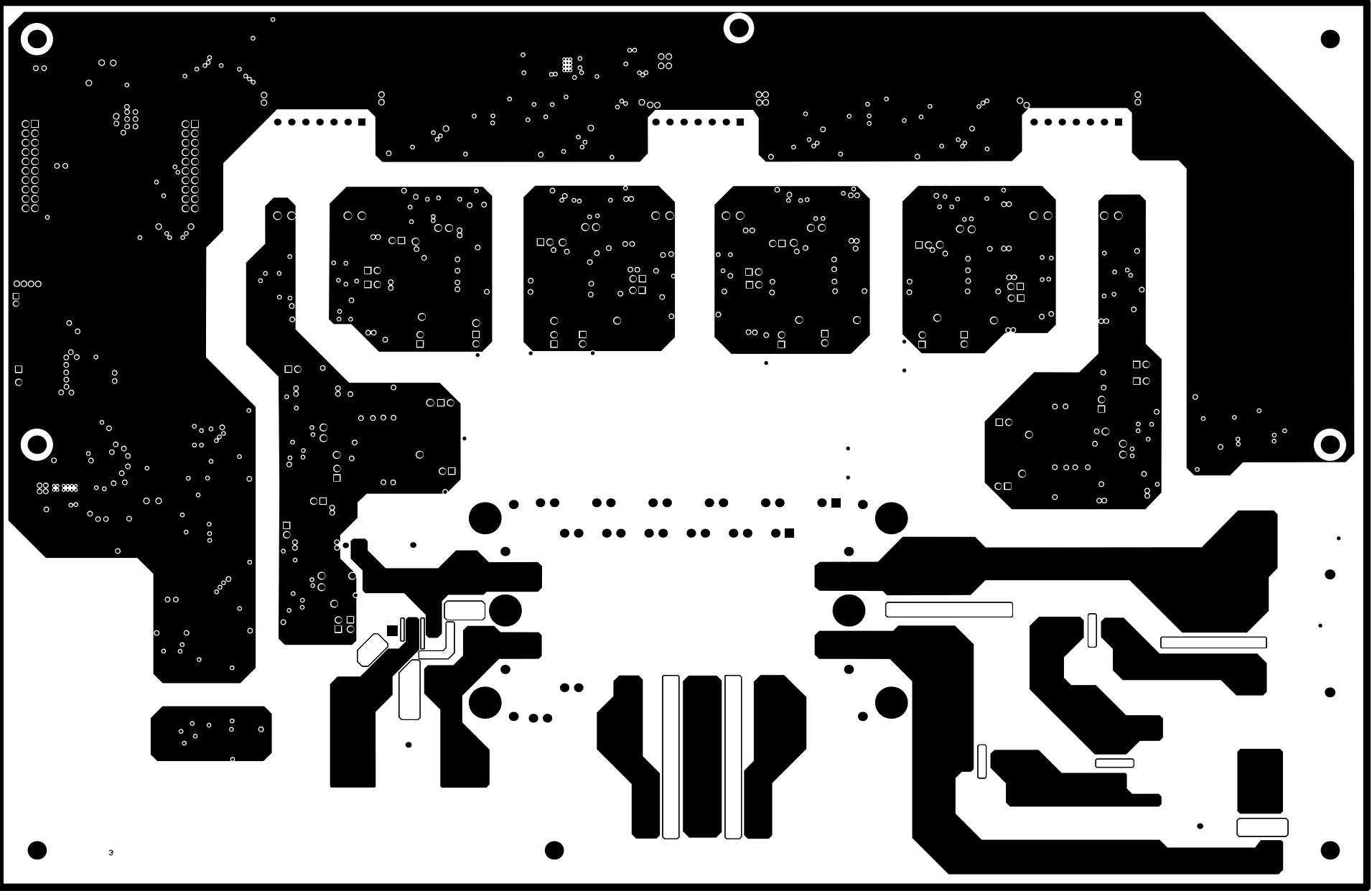
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = SOLDER MASK TOP			
PLOT NAME = Top Solder Mask Print	GENERATED : 23-03-2015 18:04:49	TEXAS INSTRUMENTS	



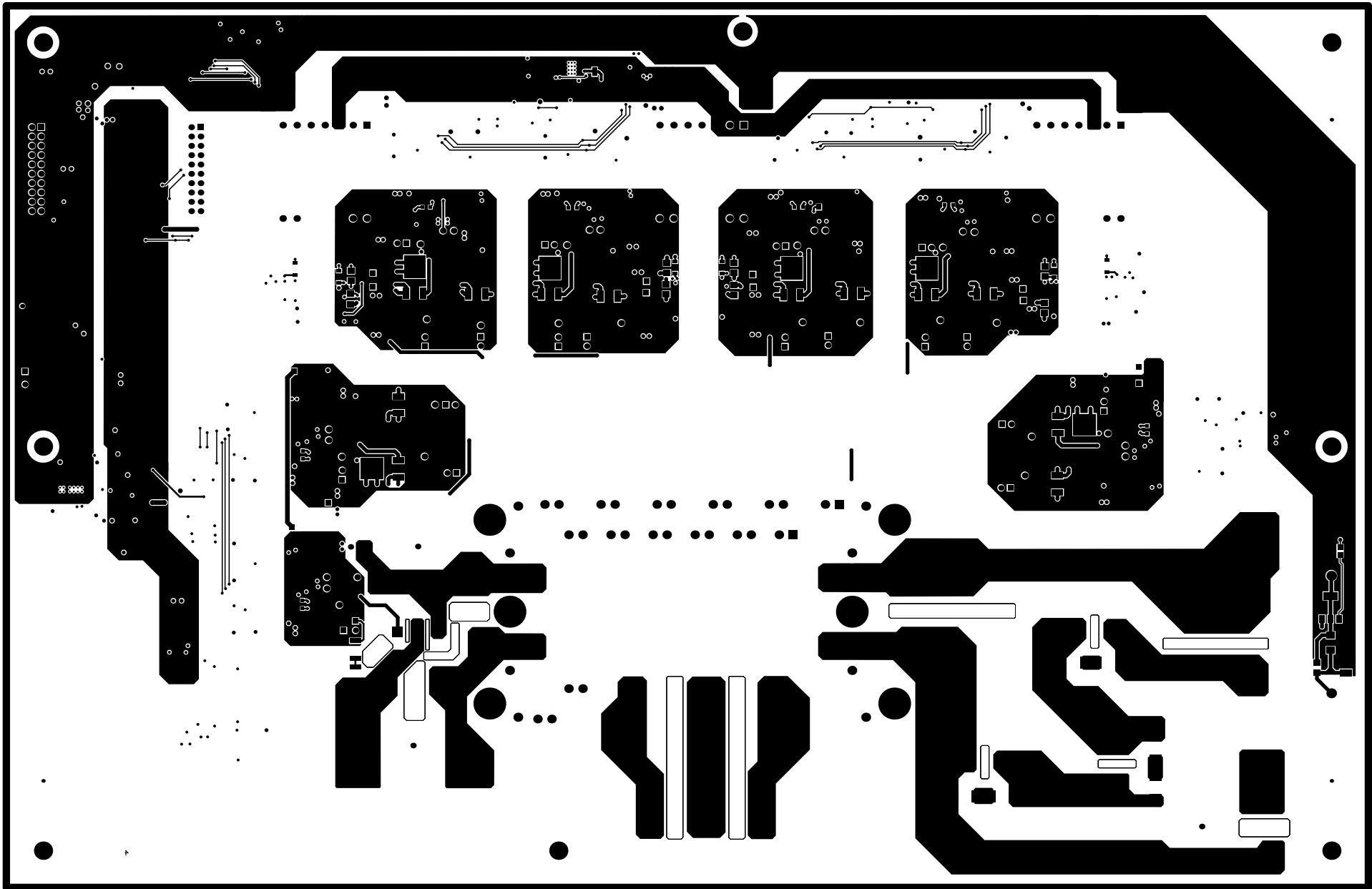
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = TOP_LAYER			
PLOT NAME = Top Layer	GENERATED : 23-03-2015 18:04:50	TEXAS INSTRUMENTS	



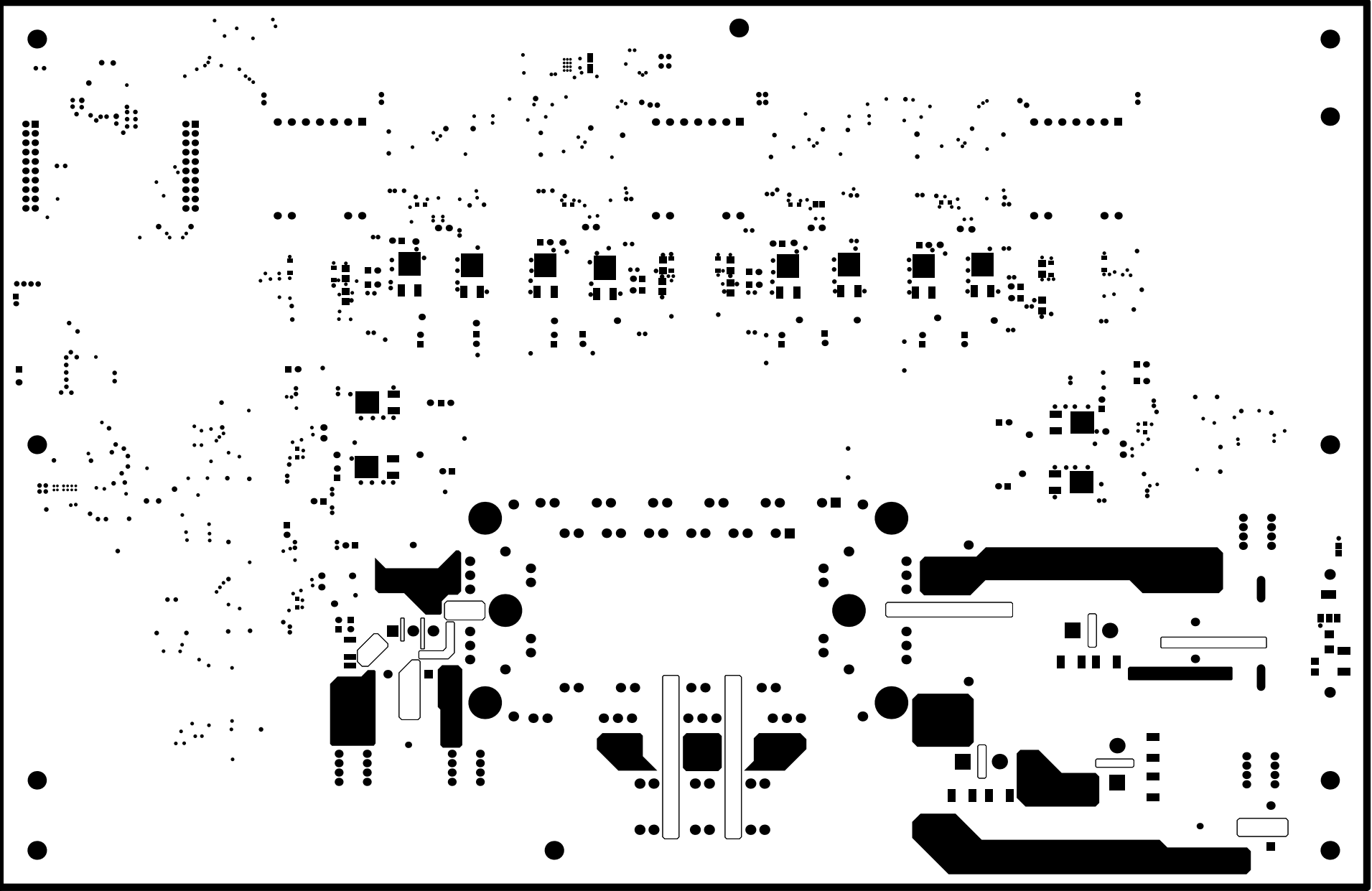
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = LAYER2_GROUND PLANE			
PLOT NAME = gnd	GENERATED : 23-03-2015 18:04:50	TEXAS INSTRUMENTS	



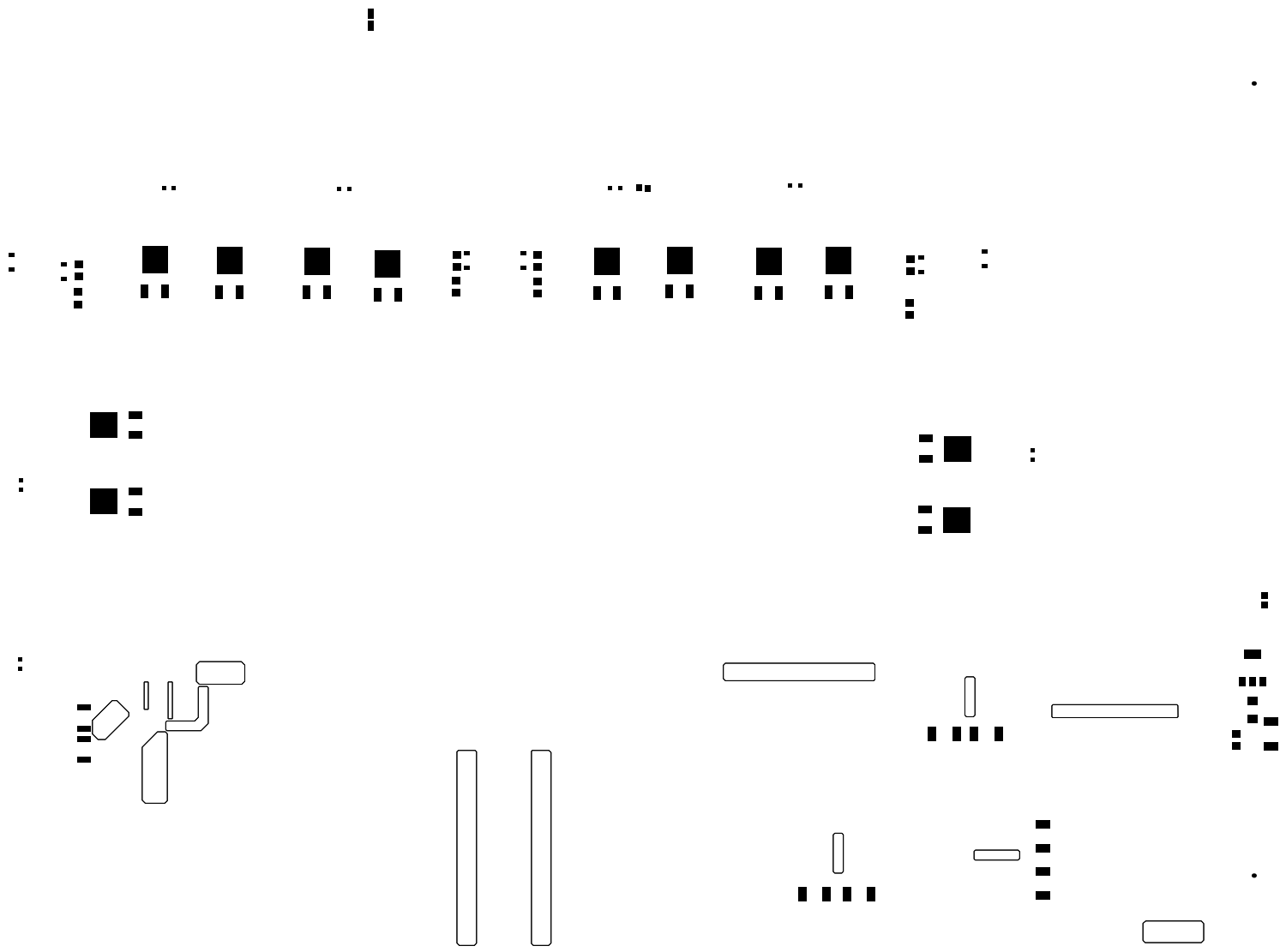
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = LAYER3_POWER PLANE			
PLOT NAME = vcc	GENERATED : 23-03-2015 18:04:50	TEXAS INSTRUMENTS	



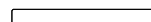
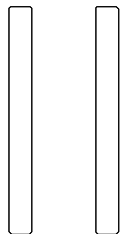
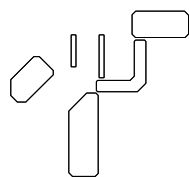
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	BOTTOM LAYER		
PLOT NAME =	Bottom Layer	GENERATED : 23-03-2015 18:04:50	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = SOLDER MASK BOTTOM			
PLOT NAME = Bottom Solder Mask Print	GENERATED : 23-03-2015 18:04:50	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	BOTTOM PASTE		
PLOT NAME = Bottom Paste Mask Print	GENERATED : 23-03-2015 18:04:51	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00195	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = MI Board Outline			
PLOT NAME = MI Board Outline	GENERATED : 23-03-2015 18:04:51	TEXAS INSTRUMENTS	

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